Adhesives and Bonding Tools

CC-33A

Instantaneous

adhesive cured at

normal temperature

-196 to 120

(Regular temperature: 20 to 80)

•Metals (Steel, stainless

Plastics (Acrylate, PVC,

•Composite materials

(CFRP, GFRP, PCB, etc.)

Apply finger pressure (100)

to 300 kPa) for 15 to 60

seconds. (Then, leave the

application time differs

gage for 1 hour.)

depending on

The lower the

finger pressure application time required

temperature and

temperature and

humidity, the longer the

1 type of

cyanoacrylate liquid

 $2g \times 1$ or $2g \times 5$

•Suitable for bonding

which are used for

general stress

temperature.

workability.

from bonding.

general-purpose gages

measurement at normal

•Enables measurement in

approximately 1 hour

KFGS. KFGT, KFRB, KFWB,

KFWS, KFRPB, KFRS, KFP,

KSPB, KSN (Excl. E5)

•Quick curing ensures

smooth bonding

humidity conditions.

The finger pressure

nylon, etc.)

•Rubber

steel, copper, aluminum

alloys A1050, A2024, etc.)

To obtain good measurement results, the strain gage must be bonded firmly to the measuring object. Thus, it is important to select an adhesive suitable for the materials of both the object being measured and the gage base, as well as for the measuring conditions.

CC-35

Instantaneous

Concrete

Mortar

•Wood

adhesive cured at

normal temperature

-30 to 120

•Apply finger pressure (100

to 300 kPa) for 30 to 180

leave the gage for 1 hour

application time differs

seconds. (After curing,

*The finger pressure

depending on

The lower the

temperature and

temperature and

finger pressure

humidity conditions.

humidity, the longer the

application time required

1 type of

cyanoacrylate liquid

 $2 g \times 1 \text{ or } 2 g \times 5$

•High viscosity makes it

suitable for bonding to

porous materials such

lumber and concrete

general-purpose gages

measurement at normal

•Suitable for bonding

which are used for

general stress

temperature.

KFGS, KFGT, KFRB,

KC, KFRPB, KFP

or more.)

(Regular temperature: 20 to 80) (Regular temperature: 20 to 80)

etc.)

 Concrete Mortar •Wood

Rubber

or more.)

CC-36

Instantaneous

adhesive cured at

normal temperature

-30 to 100

•Metals (Steel, stainless

alloys A1050, A2024,

Plastics (Acrylate, PVC,

Composite materials

(CFRP, GFRP, PCB, etc.)

steel, copper, aluminum

A7075, magnesium alloy,

nylon, polypropylene, etc.)

•Apply finger pressure (100

to 300 kPa) for 30 to 60

leave the gage for 1 hour

application time differs

humidity, the longer the

application time required

1 type of

cyanoacrylate liquid

 $2 g \times 1 \text{ or } 2 g \times 5$

•Suitable for bonding a

high-elongation gage

(such as KFEM and KFEL)

at normal temperature.

•Suitable for bonding to

non-adhesive materials

such as aluminum alloy

High peeling resistance,

high impact resistance

KFEM, KFEL, KFGS, KFGT,

KFRB, KFWB, KFWS, KFRPB,

(A7075) and

and less aging

KFRS, KFP, KSPB,

deterioration of bonding strength

magnesium alloy.

seconds. (After curing,

The finger pressure

depending on

The lower the

temperature and

temperature and

finger pressure

humidity conditions

EP-270

normal temperature

-269 to 30

•Metals (Steel, stainless steel,

aluminum alloy, etc.)

Apply pressure

at approx. 25°C.

(50 ±20 kPa) for 24 hours

2 types of

epoxy liquid mixed

Main agent: 25 g

Curing agent: 25 g

measurement at very low

•Suitable for bonding

gages for strain

temperature.

KFLB

50 a

Cured at

Non importable

KFR

EP-340

normal temperature

-55 to 150

Metals (Steel, stainless)

•Apply pressure (100

approx. 25°C or for

2 hours at 80°C.

tape.

30 g

±50 kPa) for 24 hours at

•Pressing is possible with

2 types of

/Main agent: 6 g x 4

Curing agent: 1.5 g x 4

Suitable for bonding

measurement at mid

KFGS, KFRB, KFWB, KFGT,

KFF, KFSE

gages for strain

temperature.

epoxy liquid mixed

steel, aluminum alloy, etc.

Cured at

or by heating

EP-34B

normal temperature

-55 to 200

Metals (Steel, stainless)

Composite materials

(CFRP, GFRP, PCB, etc.)

•Apply pressure (30 to

approx. 25°C or for

2 hours at 80°C.

tape.

50 kPa) for 24 hours at

Pressing is possible with

2 types of

epoxy liquid mixed

Main agent: 5.6 g x 4

Curing agent: 2.1 g x 4

Suitable for bonding

measurement at mid

temperature and for

bonding gages for

KFRPB, KFP, KFHB

transducers.

gages for strain

30.8 g

alloy, etc.)

steel, copper, aluminum

Plastics (Acrylate, PVC, etc.)

Cured at

or by heating

Models

Types

(°C)

Major

Curing

Category

Capacity

Features

Major

Gages

Applicable

Requirements

Applicable

Materials

Operating

Temperature

-47

Strain Gages	

Waterproof

Concrete

Composite materia PCB

Plastics Ultra-small strain

High temp Low temp

High elongation

Non magnetoresistive

Hydrogen gas Bending

With protector Embedded

Crack

Adhesive

Coating agent Custom

1-47

designed

Note: The stated operating te ns with gages. When using the adhesives and gages together, read the attached instruction manual carefully.

KSPH, KSPLB, KFLB, KFNB, KFSB, KFF, KCH, KV		KSN (Excl. E5), KSPH, KSPLB, KFF, KV		
mperature range is for the adhesive only, and may differ depending on combination				

Contraction of the second seco		strain page comont PI-32 = strains
EP-370	PC-600	PI-32
Cured by normal temperature + heating	Cured by heating	Cured by heating
Normal temp. to 50	-269 to 250	-269 to 350
 Metals (Steel, stainless steel, copper, aluminum alloy, etc.) Plastics (Acrylate, PVC, etc.) 	•Metals (Steel, stainless steel, copper, aluminum alloy, etc.)	•Metals (Steel, stainless steel, copper, aluminum alloy, etc.)
•Keep at normal temperature for 24 hours and heat it for 5 hours at 80 °C.	•Apply pressure (150 to 300 kPa) for 1 hour at 80°C $\rightarrow 2 \text{ hours at } 130^{\circ}\text{C}$ $\rightarrow 2 \text{ hours at } 150^{\circ}\text{C}$.	 Apply pressure (200 to 500 kPa) for 1 hour at 100°C →2 hours at 200°C →2 hours at the operating temperature with the pressure removed. *If it is difficult to heat at 200°C, 2 h at 200°C may be changed to 5 h at 160°C with all other conditions followed.
2 types of epoxy liquid mixed	1 heating type of phenol liquid	1 heating type of polyimide liquid
40 g (Main agent: 30 g Curing agent: 10 g	100 g	20 g
•Low viscosity makes it suitable for bonding gages (KFB) in bolts.	•Suitable for bonding gages for strain measurement at low, mid and high temperatures and for bonding gages for transducers.	•Suitable for bonding gages for strain measurement at high temperature.
KFB	KFGS, KFRB, KFHB, KFLB, KFNB	KFU, KFHB

-48

STRAIN GAGES



Outline

Lead-wire cable

General

Waterproof

Concrete

Composite materia PCB Plastics

Ultra-small strain High temp. Low temp.

High elongation

Nonmagnetoresistive

Hydrogen gas Bending

With protecto Embedded

Crack

Adhesive Coating agent

> Custom designed